## SURFACE MOUNT SILICON TRANSIENT VOLTAGE SUPPRESSOR



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## **DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CMOTVS5V7 is a Transient Voltage Suppressor (TVS) with exceptionally low leakage current characteristics. Packaged in the SOD-523 surface mount case, this space saving device is designed to protect sensitive equipment against ESD damage.

**MARKING CODE: 57** 



SOD-523 CASE

### **APPLICATIONS:**

- User interface protection
- Power rail protection
- Voltage clamping

### **FEATURES:**

- · Low leakage current
- Space saving SOD-523 package

MAXIMUM RATINGS: (T <sub>A</sub> =25°C)	SYMBOL		UNITS
Peak Power Dissipation (8x20µs)	$P_{PK}$	66	W
ESD Voltage (IEC 61000-4-2, Air)	$V_{ESD}$	15	kV
ESD Voltage (IEC 61000-4-2, Contact)	V <sub>ESD</sub>	8.0	kV
Operating and Storage Junction Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

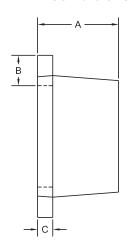
## ELECTRICAL CHARACTERISTICS: (TA=25°C) VF=1.2V MAX @ IF=20mA

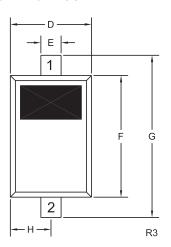
Maximum Reverse Stand-off Voltage VRWM		down tage	Test Current I <sub>T</sub>	Maximum Reverse Leakage Current IR @ VRWM	Maximum Clamping Voltage V <sub>C</sub> @ IPP	Peak Pulse Current IPP	Typical Junction Capacitance @ 0V Bias CJ
V	MIN V	MAX V	mA	μΑ	V	A	pF
4.0	5.7	6.7	5.0	0.1	12	5.5	35

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## **SOD-523 CASE - MECHANICAL OUTLINE**





LEAD CODE:

1) Cathode 2) Anode

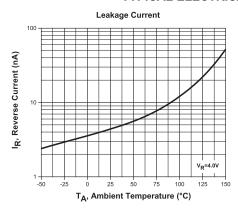
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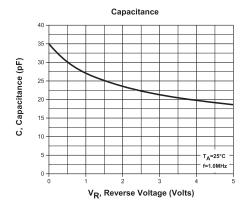
DIMENSIONS						
	INCHES		MILLIMETERS			
SYMBOL	MIN	MAX	MIN	MAX		
Α	0.020	0.031	0.50	0.80		
В	0.008	0.016	0.20	0.40		
С	0.002	0.008	0.05	0.20		
D	0.028	0.035	0.70	0.90		
E	0.008	0.014	0.20	0.35		
F	0.039	0.055	1.00	1.40		
G	0.055	0.071	1.40	1.80		
Н	0.016		0.40			
SOD-523 (REV: R3)						

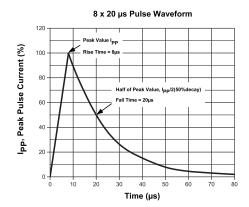


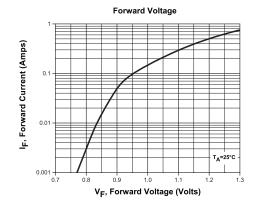
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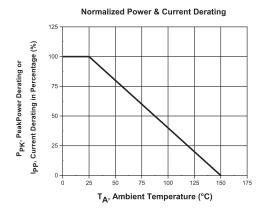
## TYPICAL ELECTRICAL CHARACTERISTICS











R3 (2-April 2015)





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R3 (2-April 2015)